FEATURES AND SPECIFICATIONS



1.27mm (.050") Pitch Micro SATA

78285 / 78103 Combo Plug

78320 / 78109 Combo Receptacle



Molex introduces the micro Serial ATA (SATA) interconnect solution for 1.8" form factor drives and backplane applications.

In April 2007, the Serial ATA International Organization (SATA-IO) annnounced the release of new specs for the SATA interconnect solutions. The new 2.6 revision covers the addition of new features to the specs making SATA available for new applications. One of the new features is the provision for the application of 1.8" SATA form factor drives in both HDD (hard disk drive) and SSD (solid state drive) types. Applications include laptop computers, set top boxes and game consoles.

Molex Micro SATA connectors are compliant to SATA-IO standards with respect to the mating interface. These standards define features such as 7 signal pins, 9 power pins with power segment key, staggered contact lengths for hot plugging, guide posts and pockets for blindmating, friction locking for cabling and high data-transfer rate of 3.0Gbps. The combo device plug supports internal 5.00mm and 8.00mm slim 1.8" form factor drives while the right angle Micro SATA combo receptacle supports backplane applications.

The connectors contained in this release are ELV and RoHS compliant. They are also lead free process compatible.

Molex is an active member of the SATA-IO. The working group is responsible for developing and specifying Serial ATA interconnect standards.

Features

- Staggered contact lengths (First-Mate-Last-Break)
- Guide pocket for plug and guide post for receptacle
- Power segment key
- High temperature thermoplastic housing
- Plastic locating peg for plug
- Metal locating pin for receptacle
- Friction locking
- Solder tab

Benefits

- Allows sequential mating of pins for hot-plugging of device drive
 Allows blind-mating
- Prevents insertion of non-micro SATA power cables
- Provides lead-free process capability
- Ensures proper locating on PCB
- Ensures proper locating on PCB and extra retention to PCB
- Ensures secure mating of connectors and cable assemblies
- Provides extra retention to PCB

SPECIIFICATIONS : PLUG

Reference Information Mechanic	al		
Packaging: Tray Mating Fo	orce: 20N (4.50 lb) max. with backplane receptacle		
UL File No.: Pending	45N (10.11 lb) max. with non latching power & signal cable receptacles		
CSA File No.: Pending Unmating	Force: 2.5N (0.56 lb) min. with backplane receptacle		
Mates With: Micro SATA Combo Receptacle	8N (1.8 lb) min. with non latching power cable receptacle		
	10N (2.25 lb) min. with non latching signal cable receptacle		
Designed In: Millimeters Durability	r: 50 cycles for internal cable application		
•	500 cycles for backplane application		
Electrical Physical	, , , ,,		
Voltage: 30V Max Housing:	LCP, Glass Filled, UL 94V-0, Black		
Current: 1.5A Contact:	Copper Alloy		
Contact Resistance: 30 milliohms max. Plating:			
Dielectric Withstanding Voltage: 500V AC	Contact Area — 0.76µm min. Gold (Au)		
Insulation Resistance: 1000 Megohms min.	Solder Tail Area — 0.05µm min. Gold (Au)		
-	Underplating — Nickel (Ni)		
PCB Thick	PCB Thickness: 0.35mm		
Operating	Operating Temperature: -40°C to +105°C		

SPECIIFICATIONS : RECEPTACLE

Reference Information Packaging: Tray UL File No.: Pending CSA File No.: Pending Mates With: Micro SATA Combo Plug Designed In: Millimeters

Electrical Voltage: 30V Max Current: 1.5A Contact Resistance: 30 milliohms max. Dielectric Withstanding Voltage: 500V AC Insulation Resistance: 1000 Megohms min.



Mating Force: 20N (4.50 lb) max. Insertion Force

Durability: 500 cycles for backplane application.

Contact Area — 0.76µm min. Gold (Au)

Operating Temperature: -40°C to +105°C

Solder Tail Area — Tin (Sn) Underplating — Nickel (Ni)

Unmating Force: 2.5N (0.56 lb) min. Removal Force

Housing: Nylon (PA) 9T, Glass Filled, UL 94V-0, Black

Mechanical

Physical

Plating:

Contact: Copper Alloy

PCB Thickness: 0.80mm

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MARKETS AND APPLICATIONS

Regional Markets, Applications and Typical Customers

- Mobile Computing
 - Notebook PC
 - Sub-notebook PC
- Emerging Trends
 - Set Top Box
 - Game Consol
 - Solid State Drives

ORDERING INFORMATION



Description	Order No.	Drive Type	Mating Z-Height	Drive form factor
1.27mm (.050") Pitch Micro SATA Device Plug, Surface Mount	78103-0001	HDD	Datum A to PCB sitting plane, 3.15mm	
	78285-0001	SSD	Datum A to PCB sitting plane, 1.29mm	
1.27mm (.050") Pitch Micro SATA Right Angle, Receptacle, Surface Mount	78109-0001	HDD / SSD	Datum A to PCB sitting plane, 1.15mm, Mid Mount	1.8″
	78320-0001		Datum A to PCB sitting surface, 3.80mm, Top Mount	



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